

## 3V 330F Supercapacitor Cells

- 3V DC output
- 330F Capacitance
- High cycle life of 1 million cycles
- Very high power density
- Radial terminals for PCB mounting



C35\$-3R0-0330
3.0 V
3.1 V
330 F
-0%/+20%
≤1.2 mΩ
<1.2 mA
<20 %
33 A
355 A
2.5 kA
0.41 Wh
5.8 Wh/kg
12.7 kW/kg
26.4 kW/kg

THERMAL CHARACTERISTICS		
Туре	C35S-3R0-0330	
Working Temperature	-40~65 °C	
Storage Temperature <sup>13</sup>	-40~70 °C	
Thermal Resistance R <sub>Th</sub> <sup>14</sup>	11.7 K/W	
Thermal Capacitance C <sub>th</sub> <sup>15</sup>	82 J/K	

SAFERTY & ENVIRONMENTAL SPECIFICATIONS			
TYPE	C35S-3R0-0330		
Safety	RoHS, REACH and UL810A		
Vibration	ISO16750 Table 12 IEC 60068-2-64 (Table A.5/A.6)		
Shock	IEC 60068-2-27		

LIFETIME CHARACTERISTICS		
TYPE	C35S-3R0-0330	
DC Life at High Temperature 16	1500 hours	
DC Life at RT <sup>17</sup>	10 years	
Cycle Life <sup>18</sup>	1,000,000 cycles	
Shelf Life <sup>19</sup>	4 years	

PHYSICAL PARAMETERS				
TYPE		C35S-3R0-0330		
Mass M		71 g		
Terminals(leads) <sup>2</sup>	20	Solderable		
Dimensions <sup>21</sup>	Height	62.7 mm		
	Diameter	35 mm		







## NOTES:

TYPE C358-3R0-0330

- Surge voltage VS: Absolute maximum voltage, non-repetitive. The duration must not exceed 1 second.
- Rated capacity C: the rated capacity test method is as shown in Figure 1. The
  test current is 100 C multiple current, i.e. 0.1 A / F. if the calculated test current
  is greater than 100 A, 100 A is
  used.
- 21. Dimensions: C35S-3R0-0330

- 3. Capacitance tolerance: Typical capacity is 105% of rated capacity.
- Leakage current measurement procedure: 1) Charge the capacitor to the VR
  with a constant current (0.1 A/F, if the calculated current is >100A, then apply
  100A). 2) Hold the voltage at VR for 72h. 3) The current to maintain VR after 72
  h is the leakage current.
- Self-discharge rate measurement procedure: 1) Charge the capacitor to VR with a constant current (0.1 A/F, if the calculated current >100A, then apply 100A).
   Hold the voltage at VR for 3h. 3) Floating for 72h. 4) Measure the voltage after 72 h.
- Max constant working current: I<sub>MCC</sub> = √ΔT/(ESR\*R<sub>Th</sub>) the working current of the supercapacitor in static air depends on the natural convection heat dissipation of the shell and the Joule heat balance.
- Max current: IMax = 0.5C \* VR (Δt + ESR \* C) , discharge from VR to VR /2 in 1 second
- Short current: Is = VR /ESR Each parameter adopts SI system unit or its conversion unit. This current can't be used as working current.
- 9. Stored energy:  $E = 0.5C*V^2/3600$ .
- 10. Energy density:  $E_d = E/M$
- 11. Usable power density:  $P_d = 0.12V_R^2/(ESR*M)$ .
- 12. Impedance match power density:  $P_{dMax} = 0.25V_R^2/(ESR*M)$
- 13. Storage temperature: discharged state(cell voltage < 0.2 V).
- 14. Thermal resistance:  $R_{Th} = 1/(h * A)$ , where h=10 W/(m2\*K), A=surface area.
- 15. Thermal capacitance: For the whole capacitor.
- 16. DC Life at High Temperature: Under the maximum working temperature of the supercapacitor (65 ° C), it is constant at its rated voltage for 1500h, the capacity is kept above 80% of the rated capacity under normal temperature, and the internal resistance is below 200% of the rated internal resistance.
- DC Life at RT: keep the supercapacitor at its rated voltage. The life criterion is that the capacity is kept above 80% of the rated capacity, and the internal resistance is below 200% of the rated internal resistance.
- Cycle life: Charge and discharged the capacitor in the range between VR and VR /2. 5 seconds waiting period between charge and discharge. The constant test current is 0.1 A/F (if the calculated current > 100A, then apply 100A).
- Storage life: within the storage temperature range, keep the discharge state, no load (cell voltage < 0.2 V).</li>
- Leading end: Tinned terminal, can weld PCB board.

- 22. Standard marking
- Name of manufacturer, part number, serial number
   Rated voltage and capacitance, negative and positive terminals, warning marking
   Stored energy in watt-hours.
- 24. Mounting recommendations:
- Provide sufficient distance between cells to meet the insulation strength.
   Keep enough space around the explosion-proof tank and keep the top clean and avoid mechanical damage.
- Recommended wave soldering profile for printed circuit assembly with use of lead-free alloy:

Total soldering process time from room temperature to peak temperature 265°Cand cool down is 10 minutes max. The time to reach the required temperatures depends on the design of the application and on the power of preheating section of the soldering machine. All temperatures are measured on the cell leads on top of the PCB. Recommended thickness for PCB = 2.4 to 3.2 mm. Conformal coating is recommended

Solder: Lead-free (Sn96.5/Ag 3.0/Cu0.5) liquidus point 217°C

Recommended Flux Kester 979T
Ramp Up Rate: 3°.5° C/sec. Max
Preheat: 140° to 155° C 2°.3° C/sec on top of board
Ramp to peak temp: 200°C/sec
Peak Temp: 265°C for 1.5 to 5 sec. Max
Cool Down Rate: 3°C.5° C /sec. Max
Max Conveyor Speed: 40.50 cm/min

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